



X Dream i117

Features

- Low profile aluminum extrusion fin with only 60mm height
- Universal mounting for Intel® socket LGA 1156 / 1155 / 775
- Compatible with Intel® latest sandy bridge platform - socket 1155
- Cross shaped design centralizes air-flow for heat dissipation
- Push-pin design for easy installation
- Silent operation at 19dBA only



■ RR-X117-18FP-R1

Compatibility

- All Intel® Socket 1156 / 1155 / 775 CPU
 - Intel® Core™ i7
 - Intel® Core™ i5
 - Intel® Core™ i3
 - Intel® Pentium®
 - Intel® Celeron®
- (For the latest CPU support information, please visit our website.)

Specifications

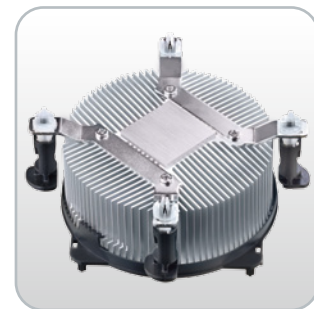
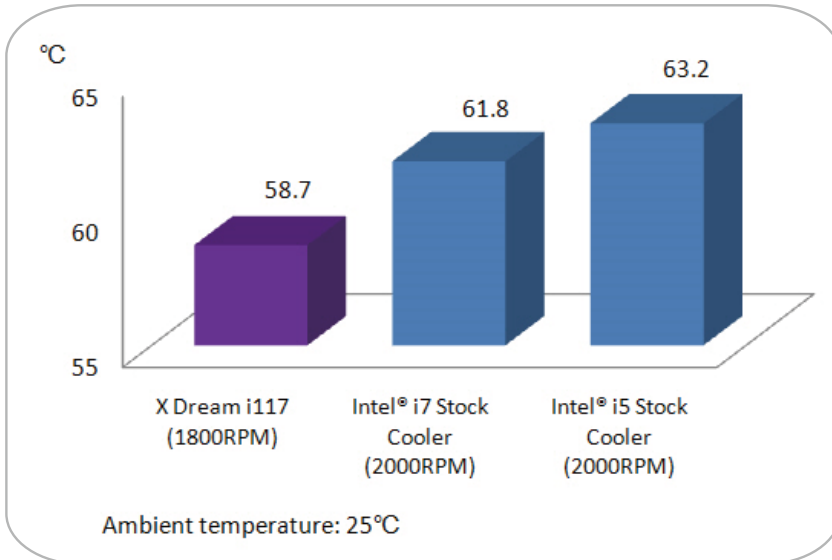
CPU Socket	Intel® Socket LGA1156/1155/775
Heatsink Dimension	112.2 x 112.2 x 60.4 mm
Heatsink Material	Aluminum
Fan Dimension	Ø 95 x 20 mm
Fan Speed	1800 R.P.M. ±10%
Fan Airflow	36.5 CFM ±10%
Fan Air Pressure	1.55 mm H2O ±10%
Fan Life Expectancy	40,000 hours
Bearing Type	Rifle bearing
Connector	3-pin
Noise Level	19 dBA
Weight	370g



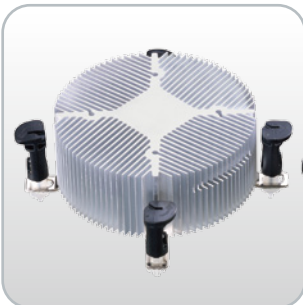
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High Performance heatsink

Aluminum extrusion fin provides superior heat dissipation performance than stock cooler.



Cross shaped design



Cross shaped design centralizes airflow for heat dissipation

Push-pin clip



Push-pin design for easy installation.

Package Information

- EAN Code: 4719512030394
- UPC Code: 884102010767
- Package dimension: 109 x 109 x 95mm
- Carton dimension: 635mm x 382mm x 241mm
- 30pcs per carton
- 32 cartons per pallet

